Docket No .:

DECLARATION AND POWER OF ATTORNEY

	As a below named invento	er. I hereby declare that:				
	My residence, post office a	und citizenship are as stated below nex	a to my name,			
•	I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plus names are listed below) of the subject matter claimed and for which a patent is sought on the invention entitled <u>CONTRO</u> APPARATUS AND METHOD FOR RELAY NODE DUPLEXING, the specification of which					
	[X] is attached hereto[ame] was filed ona	s Application Serial No (if applicable)	and was		
1	I hereby state that I have re by any amendment referre	rviewed and understand the contents o	f the above identified specifica	ation, including the claims, as amend		
	I acknowledge the duty to Code of Federal Regulation	disclose information which is known ns. Section 1.56(2).	to me to be material to pater	ntability in accordance with Title 33		
	certificate, or 365(a) of any America, listed below and	ority benefits under 35 U.S.C. 119(a)- PCT international application which have also identified below, by checkin tal application having a filing date before	h designated at least one coun g the box, any foreign applicat	try other than the United States of tion for patent or inventor's certificat		
10,00	Prior Foreign Applicatio	n(s): <u>Country</u>	Foreign Fi Month/Da	iling Date		
	42422/1999	Republic of Kores	Octobe	r 1, 1999		
: ::::::::::::::::::::::::::::::::::::						
٤	I hereby claim the benefit	under 35 U.S.C. 119(e) of any United	States provisional application	n(s) listed below.		
	Application Number(s)	Filing Date	e(Month/Day/Year)			
==						
200	Designating the United Str not disclosed in the prior C 112, Jacknowledge the du	under 35 U.S.C. 120 of any United States of America, listed below and, inse United States or PCT international app ty to disclose information which is many g date of the prior application and the	ofar as the subject matter of es olication in the manner provid aterial to patentability as defi	ach of the claims of this application led by the first paragraph of 35 U.S.C ned in 37 CFR 1.56 which became		
	Prior U.S. Application or PCT Patent Number	Filing Date(Month/I	Day/Year) Parent	Patent Number(if application)		
	belief are believed to be trulike so made are punishable	itements made herein of my own kno ie; and further that these statements we by fine or imprisonment, or both, u is may jeopardize the validity of the a	vere made with the knowledg Inder Section 1001 of Title 18	te that willful false statements and the of the United States Code and that		

FROM: GoldFax7000



I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, and Rene A. Vazquez, Registration No. 38,647; Michael J. Cornelison, Registration No. 40,395; and Stuart I. Smith, Registration No. 42,159, all of

FLESHNER & KIM P.O. Box 221200 Chantilly, Virginia 20153-1200

n full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark ice connected therewith, and all further correspondence should be addressed to them					
有光点 计设计设计 计解传播 经打工中继 法未分别 化氯化 化乙烯磺胺 化二烯甲基甲基甲基甲基甲基甲基甲基甲基甲基甲基甲基甲基甲基甲基甲基甲基甲基甲基甲基	****	40## 4%##	***	***	
Full name of solo or first inventor: In Chol JUNG				_	
Inventor's signature: In - chol Jung	Date:	Sep.	<u>ر ، کامد</u>	<u>च्या</u>	
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Full name of joint inventor(s):				_	
Inventor's signature:	Date:	·		_	
Residence:				_	
Citizenship:	-			_	
Post Office Address:				_	
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